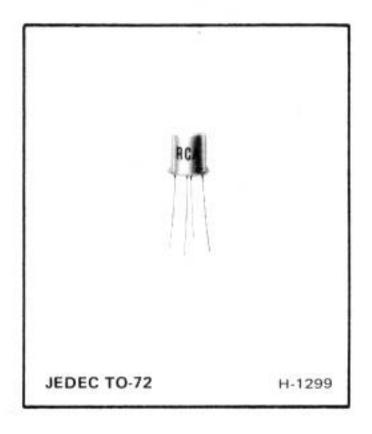


RF Power Transistors

2N3478



SILICON N-P-N EPITAXIAL PLANAR TRANSISTOR

For VHF/UHF Applications in Industrial and Commercial Equipment

Features:

- high gain-bandwidth product –
 f_T = 900 MHz typ.
- NF = 5dB typ. at 470MHz
 4.5dB max. at 200MHz
 2.5dB typ. at 60MHz
- high unneutralized power gain
 Gpe = 11.5 dB min. at 200 MHz
- hermetically sealed four-lead package
- all active elements insulated from case
- low collector-to-base feedback capacitance, C_{cb} 0.7 pF max.

RCA-2N3478 is an epitaxial planar transistor of the silicon n-p-n type with characteristics which make it extremely useful as a general purpose rf amplifier at frequencies up to 470 MHz. These characteristics include an exceptionally low noise figure at high frequencies, low leakage current, and a high gain-bandwidth product.

Maximum Ratings, Absolute-Maximum Values:

Lead Temperature (During Soldering):

At distances not closer than 1/32" to seating surface for The 2N3478 utilizes a hermetically sealed fourlead package in which active elements of the transistor are insulated from the case. The case may be grounded by means of a fourth lead in applications requiring minimum feedback capacitance, shielding of the device, or both.

Collector-to-Base Voltage, VCBO	. 30 max.	V
Collector-to-Emitter Voltage, V _{CEO}	. 15 max.	v
Emitter-to-Base Voltage, V _{EBO}	2 max.	v
Collector Current, IC	imited by d	issipation
Transistor Dissipation, PT:		
at ambient temperatures up to 25° C	200 max.	$_{\rm m}w$
temperatures 3 above 25°C		See Fig. 1
Temperature Range:		
Storage and Operating (Junction)	-65 to 200	°C

OC

ELECTRICAL CHARACTERISTICS, At an Ambient Temperature (TA) of 25° C

Characteristics	Symbols	TEST CONDITIONS					LIMITS			
		Frequency f MHz	1 100 100 100 100 100 100 100 100 100 1	DC Collector- to-Emitter Voltage VCE V		DC Collector Current I _C	Type 2N3478			Units
							Min.	Тур.	Max.	
Collector-Cutoff Current	I _{CBO}		1		0		-	-	0.02	μΑ
Collector-to-Base Breakdown Voltage	BVCBO				0	0.001	30	-	-	V
Collector-to-Emitter Breakdown Voltage	BVCEO					0,001	15	1-1	-	V
Emitter-to-Base Breakdown Voltage	BVEBO				-0.001	0	2	-	-	V
Static Forward-Current Transfer Ratio	h _{FE}			8		2	25	-	150	
Magnitude of Small-Signal Forward-Current Transfer Ratio	h _{fe} a	100		8		2	7,5	9	16	
Collector-to-Base Feedback Capacitance	Ceb	1	10		0		-	-	1	рF
Small-Signal, Common-Emitter Power Gain in Unneutralized Amplifier Circuit (See Fig. 3)	Gpea	200	a 1	8		2	11.5	-	17	dВ
Small-Signal, Common-Emitter Power Gain in Neutralized Amplifier Circuit	G _{pe} a, c	470		6		1.5	-	12	-	dB
UHF Noise Figure	NFa, c	470		6		1.5	-	5	-	d B
VHF Noise Figure (See Fig. 3)	NFa NFa, d	200 60		8		2	-	2.5	4.5	dB dB

O Fourth lead (case) grounded.

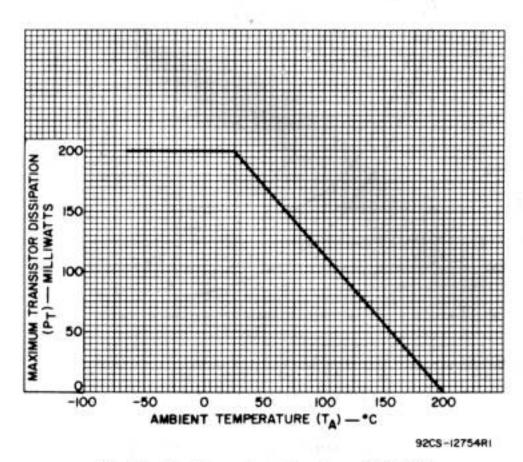


Fig.1 - Rating chart for type 2N3478

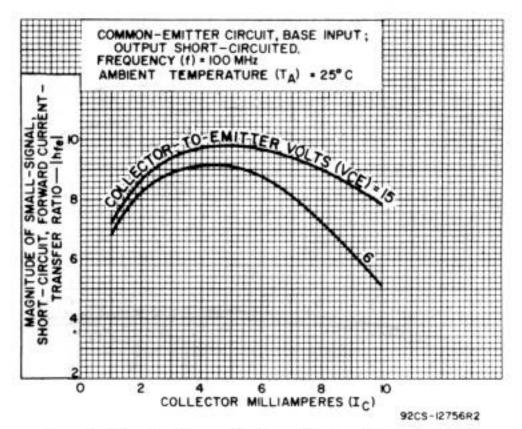


Fig. 2 - Typical small-signal beta characteristics for type 2N3478

^bC_{cb} is a three terminal measurement of the collector-to-base capacitance with the emitter and case connected to the guard terminal.

 $^{^{\}mathbf{c}}$ Source Resistance, $R_{s} = 50 \, \mathrm{ohms}$.

d Source Resistance, R_s = 400 ohms.

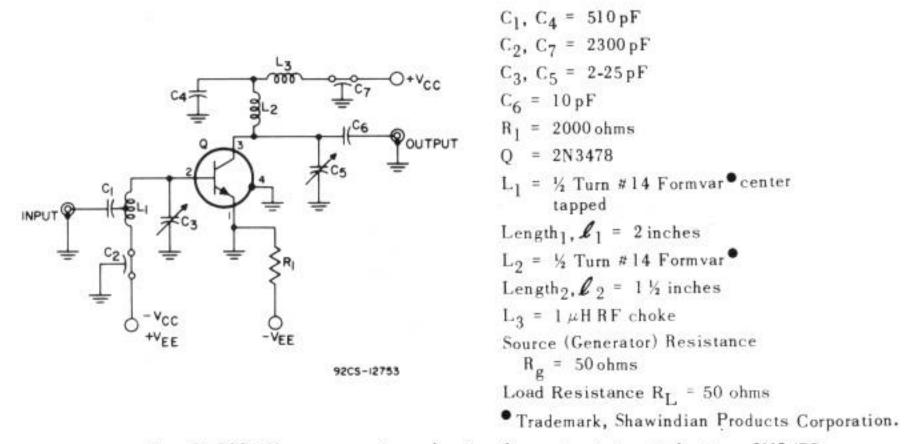


Fig. 3 - 200 MHz power gain and noise figure test circuit for type 2N3478

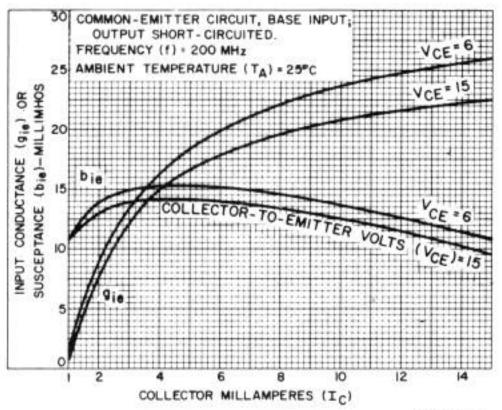


Fig. 4-Input admittance (yie) 92CS-12757RI

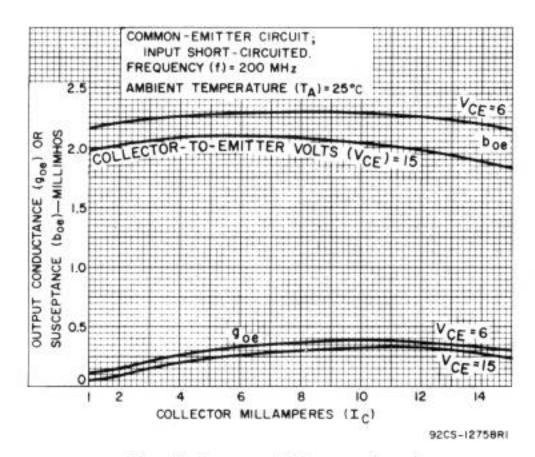


Fig. 5 - Output admittance (yoe)

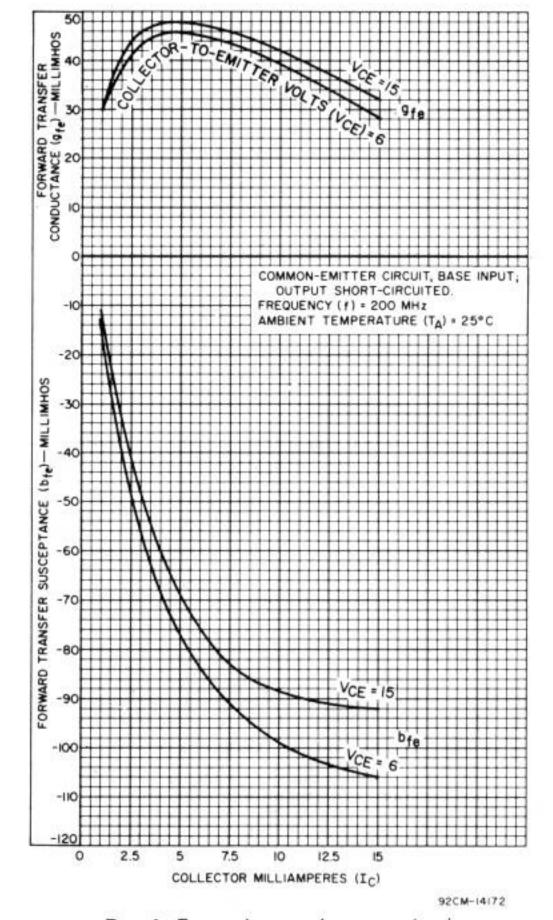


Fig. 6 - Forward transadmittance (yfe)

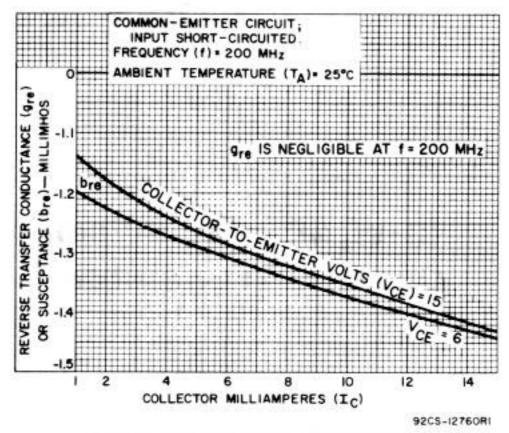
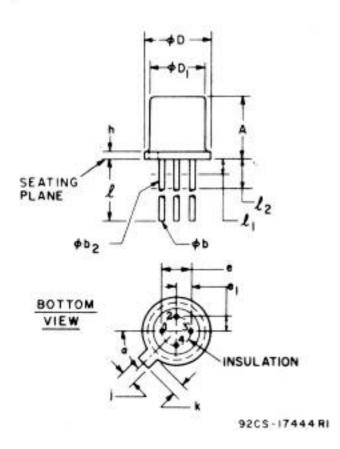


Fig. 7 - Reverse transadmittance (yre)

DIMENSIONAL OUTLINE JEDEC TO-72



TERMINAL CONNECTIONS

Lead 1 - Emitter

Lead 2 - Base

Lead 3 - Collector

Lead 4 - Connected to case

SYMBOL	INC	CHES	MILLIM		
	MIN. MAX.		MIN	MAX	NOTES
A	0.170	0.210	4.32	5.33	
φb	0.016	0.021	0.406	0.533	2
002	0.016	0.019	0.406	0.483	2 2
φD	0.209	0.230	5.31	5.84	
φD ₁	0 178	0 195	4.52	4 95	
e	0.100 T.P.		2.54 T.P.		4
e1	0.050 T.P.		1.27 T.P.		4
h	0.000.000.000	0.030	over and	0.762	
1	0.036	0.046	0.914	1.17	
k	0 028	0.048	0.711	1.22	3
1	0.500	1000000000	12.70	7.55 6455	2
11		0.050		1.27	2 2 2
12	0.250		6 35		2
a	45 T P		45° T.P.		4.6

Note 1: (Four leads). Maximum number leads omitted in this outline, "none" (0). The number and position of leads actually present are indicated in the product registration. Outline designation determined by the location and minimum angular or linear spacing of any two adjacent leads.

Note 2: (All leads) ϕb_2 applies between l_1 and l_2 , ϕb applies between l_2 and 0.50 in. (12.70 mm) from seating plane. Diameter is uncontrolled in l_1 and beyond 0.50 in. (12.70 mm) from seating plane.

Note 3: Measured from maximum diameter of the product.

Note 4: Leads having maximum diameter 0.019 in. (0.484 mm) measured in gaging plane 0.054 in. (1.37 mm) +0.001 in. (0.025 mm) -0.000 in. (0.000 mm) below the seating plane of the product shall be within 0.007 in. (0.178 mm) of their true position relative to a maximum width tab.

Note 5: The product may be measured by direct methods or by gage.

Note 6: Tab centerline.